

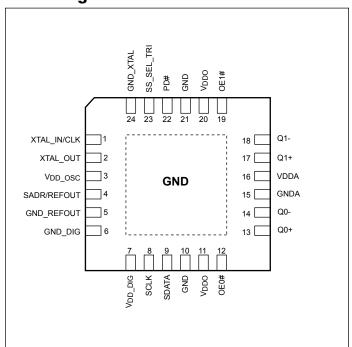


Very Low Power 2-Output PCIe Clock Generator With On-chip Termination

Features

- → 1.8V supply voltage
- → Crystal/CMOS input: 25 MHz
- → 2 differential low power HCSL outputs with on-chip termination
- → Individual output enable
- → Reference CMOS output
- → Programmable Slew rate and output amplitute for each output
- → Differential outputs blocked until PLL is locked
- → Selectable 0%, -0.25% or -0.5% spread on differential outputs
- → Strapping pins or SMBus for configuration;
- → 3.3V tolerant SMBus interface support
- → Very low jitter outputs
 - → Differential cycle-to-cycle jitter <50ps
 - → Differential output-to-output skew <50ps
 - → PCIe Gen1/Gen2/Gen3/Gen4 compliant
 - → CMOS REFOUT phase jitter is < 1.5ps RMS
- → Packaging (Pb-free & Green): 24-lead 4×4mm TQFN

Pin Configuration



Description

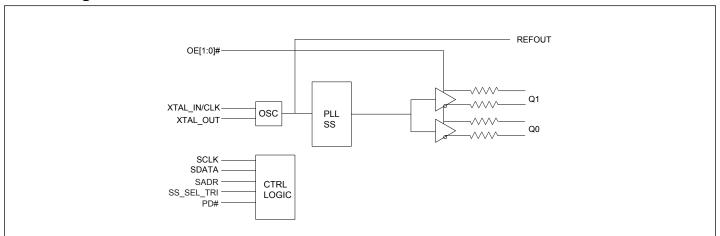
The PI6CG18201 is an 2-output very low power PCIe Gen1/Gen2/Gen3/Gen4 clock generator. It uses 25MHz crystal or CMOS reference as an input to generate the 100MHz low power differential HCSL outputs with on-chip terminations. The on-chip termination can save 8 external resistors and make layout easier. An additional buffered reference output is provided to serve as a low noise reference for other circuitry.

It uses Diodes' proprietary PLL design to achieve very low jitter that meets PCIe Gen1/Gen2/Gen3/Gen4 requirements. It also provides various options such as different slew rate and amplitude through strapping pins or SMBUS so that users can configure the device easily to get the optimized performance for their individual boards. The device also supports selectable spread-spectrum options to reduce EMI for various applications.





Block Diagram







Pin Description

| Pin# | Pin Name | Ту | pe | Description |
|--------|----------------------|------------------|-----------|---|
| 1 | XTAL_IN/CLK | Input | | Crystal input or CMOS reference input |
| 2 | XTAL_OUT | Output | | Crystal output |
| 3 | V _{DD} _OSC | Power | | Power supply for oscillator circuitry, nominal 1.8V |
| 4 | SADR/REFOUT | Input/ Output | CMOS | Latch to select SMBus Address or 1.8V LVCMOS REFOUT. This pin has an internal pull-down. |
| 5 | GND_REFOUT | Power | | Ground for REFOUT |
| 6 | GND_DIG | Power | | Ground for digital circuitry |
| 7 | V _{DD} _DIG | Power | | Power supply for digital circuitry, nominal 1.8V |
| 8 | SCLK | Input | CMOS | SMBUS clock input, 3.3V tolerant |
| 9 | SDATA | Input/ Output | CMOS | SMBUS Data line, 3.3V tolerant |
| 10, 21 | GND | Power | | Ground |
| 11, 20 | V_{DDO} | Power | | Power supply for differential outputs |
| 12 | OE0# | Input | CMOS | Active low input for enabling Q0 pair. This pin has an internal pull-down. 1 = disable outputs, 0 = enable outputs |
| 13 | Q0+ | Output | HCSL | Differential true clock output |
| 14 | Q0- | Output | HCSL | Differential complementary clock output |
| 15 | GNDA | Power | | Ground for analog circuitry |
| 16 | V_{DDA} | Power | | Power supply for analog circuitry |
| 17 | Q1+ | Output | HCSL | Differential true clock output |
| 18 | Q1- | Output | HCSL | Differential complementary clock output |
| 19 | OE1# | Input | CMOS | Active low input for enabling Q1 pair. This pin has an internal pull-down. 1 = disable outputs, 0 = enable outputs |
| 22 | PD# | Input | CMOS | Input notifies device to sample latched inputs and start up on first high assertion. Low enters Power Down Mode, subsequent high assertions exit Power Down Mode. This pin has internal pull-up resistor. |
| 23 | SS_SEL_TRI | Input | Tri-level | Latched select input to select spread spectrum amount at initial power up $1 = -0.5\%$ spread, $M = -0.25\%$, $0 = Spread Off$ |
| 24 | GND_XTAL | Power | | Ground for oscillator circuit |





SMBus Address Selection Table

| | SADR | Address | +Read/Write Bit |
|---|------|---------|-----------------|
| State of SADD on first application of DD# | 0 | 1101000 | X |
| State of SADR on first application of PD# | 1 | 1101010 | X |

Power Management Table

| PD# | SMBus OE bit | OEn# | Qn+ | Qn- | REFOUT |
|-----|--------------|------|---------|---------|---------|
| 0 | X | X | Low | Low | HiZ |
| 1 | 1 | 0 | Running | Running | Running |
| 1 | 1 | 1 | Low | Low | Low |
| 1 | 0 | X | Low | Low | Low |





Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Note: Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Operating Conditions

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Тур. | Max. | Units |
|---|--|--|------|------|------|-------|
| $V_{DDO,} \\ V_{DDA,} \\ V_{DD_OSC,} \\ V_{DD_DIG}$ | Power Supply Voltage | | 1.7 | 1.8 | 1.9 | V |
| I_{DDA} | Analog Power Supply Current | All outputs active @100MHz | | 7 | 8 | mA |
| I_{DD} | Power Supply Current | All V_{DD} , except V_{DDA} All outputs active @100MHz | | 15 | 18 | mA |
| I _{DD_WL} | Power Supply Wake-on-LAN ¹ Current | All V_{DD} , Q outputs off, REF output running | | 1.5 | 2 | mA |
| I _{DD_PD} | Power Supply Power Down ² Current | All outputs off | | 0.6 | 1 | mA |
| T_{A} | Ambient Temperature | Industrial grade | -40 | | 85 | °C |

Note:

^{1.} Wake-on-LAN mode: PD# = '0' Byte 3, bit 5 = '1'

^{2.} Power down mode: PD# = '0' Byte 3, bit 5 = '0'





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Input Electrical Characteristics

| Symbol | Parameters | Conditions | Min. | Тур. | Max. | Units |
|------------------|---|------------|------|------|------|-------|
| R _{pu} | Internal pull up resistance | | | 120 | | ΚΩ |
| R _{dn} | Internal pull down resistance | | | 120 | | ΚΩ |
| C_{XTAL} | Internal capacitance on X_IN and X_OUT pins | | | 5 | | pF |
| L _{PIN} | Pin inductance | | | | 7 | nН |

Crystal Characteristic

| Parameters | Description | Min. | Тур | Max. | Units |
|------------------|------------------------------|------|----------------------------------|------|-------|
| OSCmode | Mode of Oscillation | F | Typ Max. Fundamental 25 50 8 | | |
| FREQ | Frequency | | 25 | | MHz |
| ESR ¹ | Equivalent Series Resistance | | | 50 | Ω |
| Cload | Load Capacitance | | 8 | | pF |
| Cshunt | Shunt Capacitance | | | 7 | pF |
| | Drive Level | | | 300 | uW |

Note:

SMBus Electrical Characteristics

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Тур. | Max. | Units |
|----------------------|---------------------------|--|----------------------------|------|------|-------|
| V _{DDSMB} | Nominal bus voltage | | 1.7 | | 3.6 | V |
| | | SMBus, V _{DDSMB} = 3.3V | 2.1 | | 3.6 | |
| V _{IHSMB} | SMBus Input High Voltage | SMBus, V _{DDSMB} < 3.3V | 0.65 V _{DDSMB} | | | V |
| 17 | SMBus Input Low Voltage | SMBus, V _{DDSMB} = 3.3V | | | 0.6 | V |
| V _{ILSMB} | | SMBus, V _{DDSMB} < 3.3V | | | 0.6 | |
| I _{SMBSINK} | SMBus sink current | SMBus, at V _{OLSMB} | 4 | | | mA |
| V _{OLSMB} | SMBus Output Low Voltage | SMBus, at I _{SMBSINK} | | | 0.4 | V |
| f _{MAXSMB} | SMBus operating frequency | Maximum frequency | | | 400 | kHz |
| t _{RMSB} | SMBus rise time | (Max V _{IL} - 0.15) to (Min V _{IH} + 0.15) | | | 1000 | ns |
| t _{FMSB} | SMBus fall time | (Min V_{IH} + 0.15) to (Max V_{IL} - 0.15) | | | 300 | ns |

Spread Spectrum Characteristic

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Тур. | Max. | Units |
|-----------|-------------------------|-----------------------|------|------|------|-------|
| f_{MOD} | SS Modulation Frequency | Triangular modulation | 30 | 31.6 | 33 | kHz |

^{1.} ESR value is dependent upon frequency of oscillation





LVCMOS DC Electrical Characteristics

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Тур. | Max. | Units |
|-------------------|-----------------------|--|--------------------------|----------------|-------------------------|-------|
| V _{IH} | Input High Voltage | Single-ended inputs, except SMBus | 0.75 V _{DD} | | V _{DD} +0.3 | V |
| V_{IM} | Input Mid Voltage | SS_SEL_TRI | 0.4V _{DD} | $0.5V_{ m DD}$ | $0.6V_{\mathrm{DD}}$ | V |
| $V_{\rm IL}$ | Input Low Voltage | Single-ended inputs, except SMBus | -0.3 | | 0.25 V _{DD} | V |
| I _{IH} | Input High Current | Single-ended inputs, $V_{IN} = V_{DD}$ | | | 20 | μА |
| I _{IL} | Input Low Current | Single-ended inputs, $V_{IN} = 0V$ | -20 | | | μА |
| I _{IH} | Input High Current | Single-ended inputs with pull up / pull down resistor, $V_{\rm IN}$ = $V_{\rm DD}$ | | | 220 | μА |
| I_{IL} | Input Low Current | Single-ended inputs with pull up / pull down resistor, $V_{\rm IN} = 0V$ | -220 | | | μА |
| V _{OH} | Output High Voltage | REFOUT, except SMBus; I _{OH} = -2mA | V _{DD} -0.45 | | | V |
| V _{OL} | Output Low Voltage | REFOUT, except SMBus; I _{OH} = 2mA | | | 0.45 | V |
| R _{OUT} | CMOS Output impedance | | | 20 | | Ω |
| C _{IN} | Input Capacitance | | 1.5 | | 5 | pF |

LVCMOS AC Characteristics

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Тур. | Max. | Units |
|---------------------|--------------------------------|---|------|------|------|--------|
| f _{INPUT} | Input Frequency | XTAL_IN/CLK | 23 | 25 | 27 | MHz |
| t _{RIN} | Input rise time | Single-ended inputs | | | 5 | ns |
| t _{FIN} | Input fall time | Single-ended inputs | | | 5 | ns |
| t _{STAB} | Clock stablization | From Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock | | 0.6 | 1.8 | ms |
| t _{OELAT} | Output enable latency | Q start after OE# assertion Q stop after OE# deassertion | 1 | | 3 | clocks |
| t _{PDLAT} | PD# de-assertion | Differential outputs enable after PD# deassertion | | | 300 | us |
| t _{PERIOD} | REFOUT clock period | REFOUT, assume input is at 25MHz | | 40 | | ns |
| f_{ACC} | REFOUT frequency accuracy 1 | REFOUT, long term accuracy to input | | 0 | | ppm |
| | | Byte 3 = 1F, 20% to 80% of V _{DDREF} | | 1 | 2.5 | V/ns |
| | REFOUT slew rate ¹ | Byte 3 = 5F, 20% to 80% of V _{DDREF} | | 1.6 | 2.5 | V/ns |
| t _{SLEW} | REFOUT slew rate | Byte 3 = 9F, 20% to 80% of V _{DDREF} | | 2.0 | 2.5 | V/ns |
| | | Byte 3 = DF, 20% to 80% of V _{DDREF} | | 2.1 | 2.5 | V/ns |
| t_{DC} | REFOUT Duty Cycle ¹ | $V_T = V_{\rm DD}$ /2 V, driven by a Xtal | 45 | 50 | 55 | % |





LVCMOS AC Characteristics (Cont.)

| Symbol | Parameters | Condition | Min. | Тур. | Max. | Units |
|--------------------|------------------------------|---|------|------|------|-------|
| t _{DCDIS} | REFOUT Duty Cycle Distortion | $V_T = V_{DD}$ /2 V, driven by an external source | 0 | 2 | 4 | % |
| t _{JITCC} | REFOUT cycle-cycle jitter | $V_T = V_{DD} / 2 V$, driven by a Xtal | | 20 | 250 | ps |
| t _{JITPH} | REFOUT phase jitter | 12kHz to 5MHz, RMS, driven by a Xtal | | 0.68 | 1.5 | ps |
| 4 | Naise flagg | 1kHz offset, driven by a Xtal | | -130 | -105 | dBc |
| t _{JITN} | Noise floor | 10kHz offset to Nyquist, driven by a Xtal | | -140 | -120 | dBc |

Note:

HCSL Output Characteristics

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Condition | Min. | Тур. | Max. | Units |
|-------------------|---|--|------|------|------|-------|
| V _{OH} | Output Voltage High ¹ | Statistical measurement on single-ended | 660 | 784 | | mV |
| V _{OL} | Output Voltage Low ¹ | signal using oscilloscope math function | -150 | | 150 | mV |
| V _{OMAX} | Output Voltage Maximum ¹ | Measurement on single ended signal using | | 816 | 1150 | mV |
| V _{OMIN} | Output Voltage Minimum ¹ | absolute value | -300 | -15 | | mV |
| Voswing | Output Swing Voltage 1,2,3 | Scope averaging off | 300 | 1551 | | mV |
| V _{OC} | Output Cross Voltage 1,2,4 | | 250 | 400 | 550 | mV |
| DV _{OC} | V _{OC} Magnitude Change ^{1,2,5} | | | 14 | 140 | mV |

Note:

- 1. At default SMBUS amplitude settings
- 2. Guaranteed by design and characterization, not 100% tested in production
- 3. Measured from differential waveform
- 4. This one is defined as voltage where Q+ = Q- measured on a component test board and only applied to the differential rising edge
- 5. The total variation of all Vcross measurements in any particular system. This is a subset of Vcross_min/max allowed.

HCSL Output AC Characteristics

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Condition | Min. | Тур. | Max. | Units |
|----------------------|--------------------------------------|-----------------------------------|------|------|------|-------|
| f _{OUT} | Output Frequency | | | 100 | | MHz |
| | Slew rate ^{1,2,3} | Scope averaging on fast setting | 2.9 | 3.1 | 5.7 | V/ns |
| t _{RF} | Siew rate | Scope averaging on slow setting | 1.1 | 2.0 | 3.0 | V/ns |
| Dt _{RF} | Slew rate matching 1,2,4 | Scope averaging on | | 3 | | % |
| t _{DC} | Duty Cycle ^{1,2} | Measured differentially, PLL Mode | 45 | 50 | 55 | % |
| t _{SKEW} | Output Skew ^{1,2} | Averaging on, $V_T = 50\%$ | | 34 | 50 | ps |
| tj _{c-c} | Cycle to cycle jitter ^{1,2} | | | 14 | 55 | ps |
| t _{STARTUP} | Start up time | | | | 10 | ms |
| t _{LOCK} | PLL lock time | | | | 20 | ms |

^{1.} Guaranteed by design and characterization, not 100% tested in production





HCSL Output AC Characteristics (continued)

| Symbol | Parameters | Condition | Min. | Тур. | Max. | Units |
|---------------------|-------------------------------------|--|------|------|------|-------|
| | | PCIe Gen 1 | 20 | 25 | 86 | ps |
| | | PCIe Gen 2 Low Band, 10kHz < f < 1.5MHz | 0.8 | 0.9 | 3.0 | ps |
| tj _{PHASE} | Integrated phase jitter (RMS) 1,5,6 | PCIe Gen 2 High Band, 1.5MHz < f < Nyquist (50MHz) | 1.5 | 1.6 | 3.1 | ps |
| GPHASE | | PCIe Gen 3 Common Clock Architecture (PLL BW of 2-4 or 2-5MHz, CDR =10MHz) | 0.4 | 0.5 | 1.0 | ps |
| | | PCIe Gen 4 (PLL BW of 2-4 or 2-5MHz, CDR =10MHz) | 0.25 | 0.3 | 0.5 | ps |

Note:

- 1. Guaranteed by design and characterization, not 100% tested in production
- 2. Measured from differential waveform
- $3. \ Slew\ rate\ is\ measured\ through\ the\ Vswing\ voltage\ range\ centered\ around\ differential\ 0V,\ within\ +/-150mV\ window$
- 4. It is measured using a +/-75mV window centered on the average cross point
- 5. See http://www.pcisig.com for complete specs
- 6. Sample size of at least 100k cycles. This can be extrapolated to 108ps pk-pk @ 1M cycles for a BER of $10^{-12}\,$

Differential Output Clock Periods - Spread Spectrum Disabled 1, 2

| | | | Mea | surement Wir | ıdow | | | |
|--------------|------------------------------|---------------------------------|--------------------------------|----------------------------|-------------------------------|---------------------------------|------------------------------|-------|
| Center | 1 clock | 1 us | 0.1 s | 0.1 s | 0.1 s | 1 us | 1 clock | |
| Freq. MHz | -c2c jitter AbsPer Min | - SSC Short-term Avg. Min | -ppm Long- term Avg. min | 0 ppm Period Nominal | +ppm Long-term Avg. max | + SSC Short-term Avg. Max | -c2c jitter AbsPer Max | Units |
| 100.00 | 9.94900 | | 9.99900 | 10.00000 | 10.00100 | | 10.05100 | ns |

Differential Output Clock Periods - Spread Spectrum Enabled ^{1, 2}

| | | | Mea | surement Wir | ndow | | | |
|--------------|------------------------------|---------------------------------|--------------------------------|----------------------------|-------------------------------|---------------------------------|------------------------------|-------|
| Center | 1 clock | 1 us | 0.1 s | 0.1 s | 0.1 s | 1 us | 1 clock | |
| Freq. MHz | -c2c jitter AbsPer Min | - SSC Short-term Avg. Min | -ppm Long- term Avg. min | 0 ppm Period Nominal | +ppm Long-term Avg. max | + SSC Short-term Avg. Max | -c2c jitter AbsPer Max | Units |
| 99.75 | 9.94906 | 9.99906 | 10.02406 | 10.02506 | 10.02607 | 10.05107 | 10.10107 | ns |

Note:

- 1. Guaranteed by design and characterization, not 100% tested in production
- 2. All long term accuracy and clock period specifications are guaranteed assuming REF is trimmed to 25.00MHz





SMBus Serial Data Interface

PI6CG18201 is a slave only device that supports block read and block write protocol using a single 7-bit address and read/write bit as shown below.

Read and write block transfers can be stopped after any complete byte transfer.

Address Assignment

| A6 | A5 | A4 | A3 | A2 | A1 | A0 | R/W |
|----|----|----|----|----|------|----|-----|
| 1 | 1 | 0 | 1 | 0 | SADR | 0 | 1/0 |

Note: SMBus address is latched on SADR pin

How to Write

| 1 bit | 7 bits | 1 bit | 1 bit | 8 bits | 1 bit | 8 bits | 1 bit | 8 bits | 1 bit | 8 bits | 1 bit | 1 bit |
|-----------|--------|-------|-------|-------------------------------------|-------|------------------------|-------|-------------------------|-------|--------------------------|-------|----------|
| Start bit | Add. | W(0) | Ack | Beginning Byte loca- tion = N | Ack | Data Byte count = X | Ack | Beginning Data Byte (N) | Ack | Data Byte (N+X-1) | Ack | Stop bit |

How to Read

| 1 bit | 7 bits | 1 bit | 1 bit | 8 bits | 1 bit | 1 bit | 7 bits | 1 bit | 1 bit | 8 bits | 1 bit | 8 bits | 1 bit |
|-----------|---------|-------|-------|-----------------------------|-------|---------------------|---------|-------|-------|------------------------|-------|-------------------------|-------|
| Start bit | Address | W(0) | Ack | Beginning Byte location = N | Ack | Repeat Start bit | Address | R(1) | Ack | Data Byte count = X | Ack | Beginning Data Byte (N) | Ack |

| 8 bits | 1 bit | 1 bit |
|-----------|-------|----------|
| Data Byte | NAck | Stop bit |
| (N+X-1) | IVACK | Stop bit |





Byte 0: Output Enable Register ¹

| Bit | Control Function | Description | Туре | Power Up Condition | 0 | 1 |
|-----|------------------|------------------|------|-----------------------|---------|---------|
| 7 | Reserved | | | 1 | | |
| 6 | Reserved | | | 1 | | |
| 5 | Reserved | | | 1 | | |
| 4 | Reserved | | | 1 | | |
| 3 | Reserved | | | 1 | | |
| 2 | Q1_OE | Q1 output enable | RW | 1 | Low/Low | Enabled |
| 1 | Q0_OE | Q0 output enable | RW | 1 | Low/Low | Enabled |
| 0 | Reserved | | | 1 | | |

Note:

1. A low on these bits will override the OE# pins and force the differential outputs to Low/Low states

Byte 1: SS Readback and Control Register

| Bit | Control Function | Description | Туре | Power Up Condition | 0 | 1 | |
|-----|------------------|---------------------------|-----------------|-----------------------|---|---|--|
| 7 | SSENRB1 | SS Enable Readback Bit1 | R | Latch | '00' for SS_SEL | _TRI = '0', | |
| 6 | SSENRB0 | SS Enable Readback Bit0 | R | Latch | '01' for SS_SEL_ '11' for SS_SEL_ | | |
| 5 | SSEN_SWCTR | Enable SW control of SS | RW | 0 | Values in B1[7:6] control SS amount | Values in B1[4:3] control SS amount | |
| 4 | SSENSW1 | SS enable SW control Bit1 | RW ¹ | 0 | '00' = SS off, '01 | ' = -0.25% SS, | |
| 3 | SSENSW0 | SS enable SW control Bit0 | RW ¹ | 0 | '10' = Reserved, | '11' = -0.5% SS | |
| 2 | Reserved | | | 1 | | | |
| 1 | Amplitude1 | Control output applitudo | RW | 1 | '00' = 0.6V, '01' = | = 0.7V, '10' = | |
| 0 | Amplitude0 | Control output applitude | RW 0 | | 0.8V, '11' = 0.9V | | |

Note:

 $1.\ B1[5]$ must be set to a 1 for these bits to have any effect on the part.





Byte 2: Differential Output Slew Rate Control Register

| Bit | Control Function | Description | Туре | Power Up Condition | 0 | 1 |
|-----|------------------|-------------------------|------|-----------------------|--------------|--------------|
| 7 | Reserved | | | 1 | | |
| 6 | Reserved | | | 1 | | |
| 5 | Reserved | | | 1 | | |
| 4 | Reserved | | | 1 | | |
| 3 | Reserved | | | 1 | | |
| 2 | SLEWRATECTR_Q1 | Control slew rate of Q1 | RW | 1 | Slow setting | Fast setting |
| 1 | SLEWRATECTR_Q0 | Control slew rate of Q0 | RW | 1 | Slow setting | Fast setting |
| 0 | Reserved | | | 1 | | |

Byte 3: REF Control Register

| Bit | Control Function | Description | Туре | Power Up Condition | 0 | 1 |
|-----|------------------|-----------------------------|------|-----------------------|--------------------|--------------------|
| 7 | DEECLEMD ATE | Classicate as at a last DEE | RW | 0 | '00' = 0.9V/ns '0 | 1' = 1.3V/ns, |
| 6 | REFSLEWRATE | Slew rate control for REF | RW | 1 | '10' = 1.6V/ns, '1 | 1' = 1.8V/ns |
| 5 | REF_PDSTATE | Wake-on-Lan enable for REF | RW | 0 | REF = 'Low' | REF = run- ning |
| 4 | REF_OE | Output enable for REF | RW | 1 | REF = "Low' | REF = run- ning |
| 3 | Reserved | | | 1 | | |
| 2 | Reserved | | | 1 | | |
| 1 | Reserved | | | 1 | | |
| 0 | Reserved | | | 1 | | |

Byte 4: Reserved

| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|-------------|------|-----------------------|---|---|
| 7:0 | Reserved | | | 1 | | |





Byte 5: Revision and Vendor ID Register

| Bit | Control Function | Description | Туре | Power Up Condition | 0 1 | |
|-----|------------------|--------------|------|-----------------------|---------------|--|
| 7 | RID3 | | R | 0 | rev = 0000 | |
| 6 | RID2 | n · · · · ID | R | 0 | | |
| 5 | RID1 | Revision ID | R | 0 | | |
| 4 | RID0 | | R | 0 | | |
| 3 | PVID3 | Vendor ID | R | 0 | | |
| 2 | PVID3 | | R | 0 | Diodes = 0011 | |
| 1 | PVID3 | | R | 1 | Diodes = 0011 | |
| 0 | PVID3 | | R | 1 | | |

Byte 6: Device Type/Device ID Register

| Bit | Control Function | Description | Туре | Power Up Condition | 0 | 1 |
|-----|------------------|-------------|------|-----------------------|----------------------|-----------|
| 7 | DTYPE1 | Device type | R | 0 | '00' = CG, '01' = | ZDB, |
| 6 | DTYPE0 | | R | 0 | '10' = Reserve, ' | 11' = ZDB |
| 5 | DID5 | Device ID | R | 0 | | |
| 4 | DID4 | | R | 0 | | |
| 3 | DID3 | | R | 0 | 000010 binary, 02Hex | |
| 2 | DID2 | | R | 0 | | |
| 1 | DID1 | | R | 1 | | |
| 0 | DID0 | | R | 0 | | |

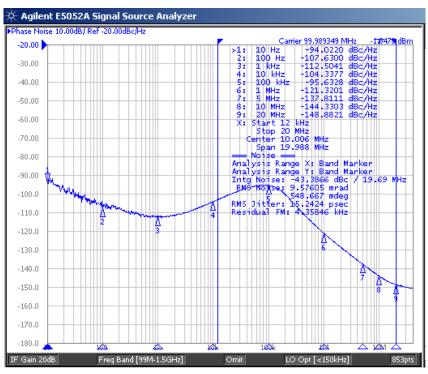
Byte 7: Byte Count Register

| Bit | Control Function | Description | Туре | Power Up Condition | 0 | 1 |
|-----|------------------|------------------------|------|-----------------------|------------------|-------------------|
| 7 | Reserved | | | 0 | | |
| 6 | Reserved | | | 0 | | |
| 5 | Reserved | | | 0 | | |
| 4 | BC4 | | RW | 0 | | |
| 3 | BC3 | | RW | 1 | Writing to this | register will |
| 2 | BC2 | Byte count programming | RW | 0 | configure how | many bytes will |
| 1 | BC1 | | RW | 0 | be read back, do | efault is 8 bytes |
| 0 | BC0 | | RW | 0 | | |

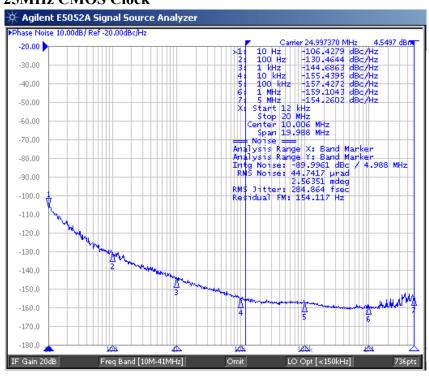




Plots 100MHz HCSL Clock



25MHz CMOS Clock







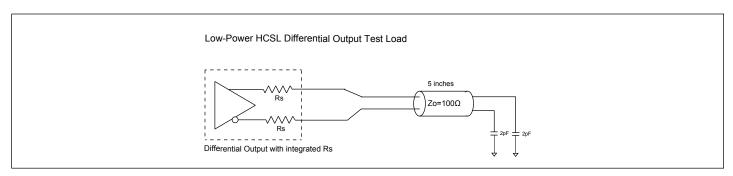


Figure 1. Low Power HCSL Test Circuit

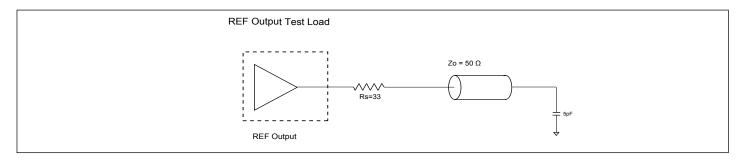


Figure 2. CMOS REF Test Circuit

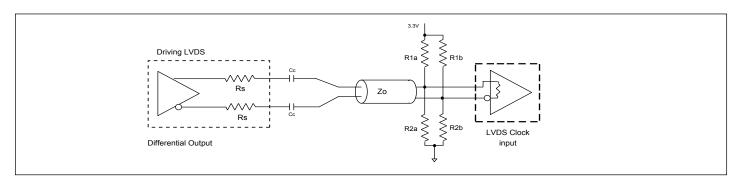


Figure 3. Differential Output driving LVDS

Alternate Differential Output Terminations

| Component | Receiver with termination | Receiver without termination | Unit |
|------------------|---------------------------|------------------------------|------|
| R_{1a}, R_{1b} | 10,000 | 140 | Ω |
| R_{2a}, R_{2b} | 5,600 | 75 | Ω |
| CC | 0.1 | 0.1 | μF |
| V_{CM} | 1.2 | 1.2 | V |





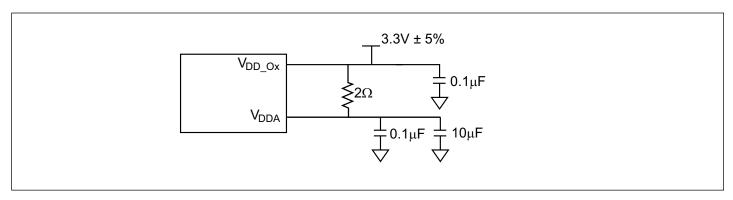


Figure 4. Power Supply Filter

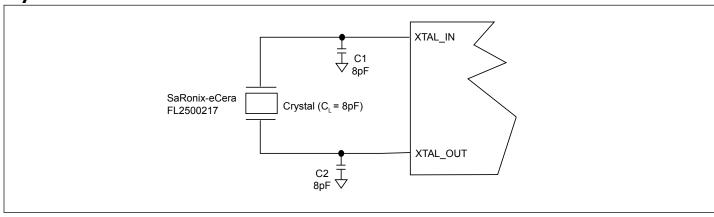




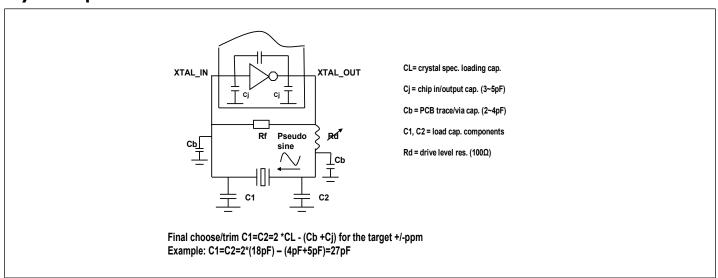
Crystal circuit connection

The following diagram shows PI6CG18201 crystal circuit connection with a parallel crystal. For the CL=8pF crystal, it is suggested to use C1=8pF, C2=8pF. C1 and C2 can be adjusted to fine tune to the target ppm of crystal oscillator according to different board layouts based on the following formular in the Crystal Capacitor Calculation diagram.

Crystal Oscillator Circuit



Crystal Capacitor Calculation



Recommended Crystal Specification

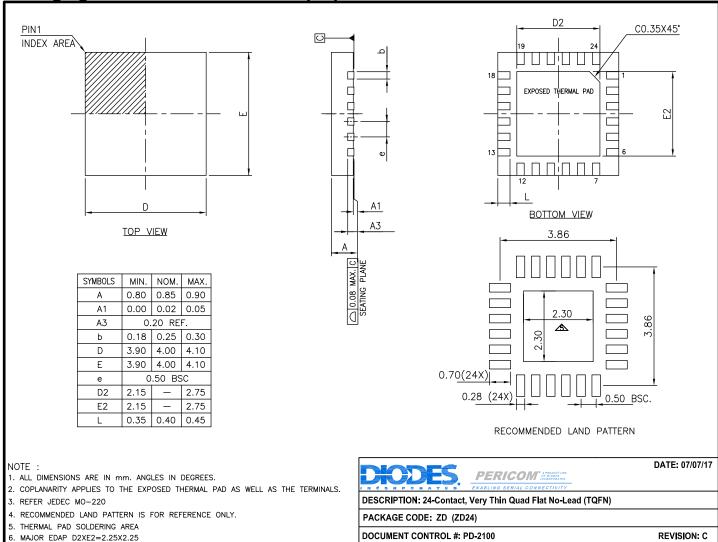
Diodes recommends:

a) FL2500217, SMD 3.2x2.5(4P), 25MHz, CL=8pF, +/-20ppm, https://www.diodes.com/assets/Datasheets/FL.pdf









7-0533

 $Note: For \ latest \ package \ info, \ please \ check: \ https://www.diodes.com/design/support/packaging/pericom-packa$

Ordering Information⁽¹⁻³⁾

| Ordering Code | Package Code | Package Description | Operating Temperature |
|-----------------|--------------|---|------------------------------|
| PI6CG18201ZDIE | ZD | 24-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN) | Industrial |
| PI6CG18201ZDIEX | ZD | 24-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN), Tape & Reel | Industrial |

Notes

- 1. Thermal characteristics can be found on the company web site at https://www.diodes.com/design/support/packaging/pericom-packaging/
- 2. E = Pb-free and Green
- 3. Adding an X suffix = Tape/Reel





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